Product Preview Antenna Tuner

INTRODUCTION

ON Semiconductor's TCT-102BB antenna tuner combines a Passive Tunable Integrated Circuit (PTIC) and an SPST switch in a single package to create a product which can be used in advanced antenna tuning designs. The high Q and wide tuning range of the PTIC give premium performance, and the SPST gives flexibility to design a variety of optimized tuner networks.

Features

- PTIC:
 - High Quality Factor (Q) for Low Loss
 - Wide Tuning Range from 2.7 pF to 0.53 pF
 - High Power Handling Capability
 - Compatible with PTIC Control ICs from ON Semiconductor
- SPST:
 - Very Low $R_{ON} = 1.3 \Omega$
 - Very Low $C_{OFF} = 130 \text{ fF}$
 - + High RF Handling Peak Voltage: 60 V

Typical Applications

- Tunable Antenna Matching Networks
- Antenna Tuning for GSM, EDGE, WDCMA, LTE and 5 G Smartphones
- Main and Diversity Antenna Tuning
- Aperture and Impedance Tuning

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

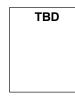


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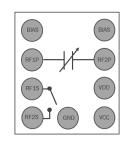
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MARKING DIAGRAM



FUNCTIONAL BLOCK DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
TCT-102BB-FT	ECP9	

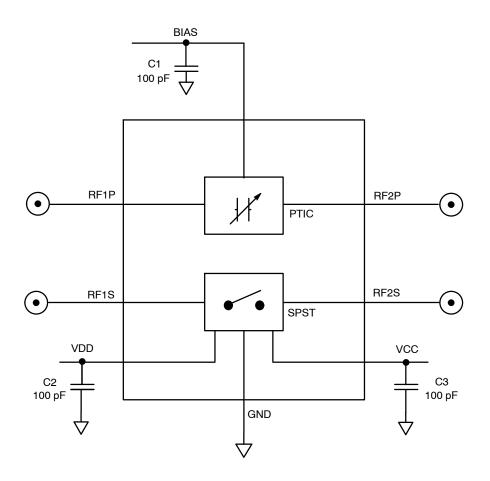


Figure 1. Application Schematic

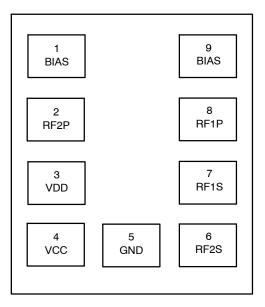


Figure 2. Pin Connections

Table 1. PIN FUNCTION DESCRIPTION

Pin No.	Symbol	Description
1	BIAS	PTIC DC Bias Voltage
2	RF2P	PTIC RF Output
3	VDD	SPST DC Supply Voltage
4	VCC	SPST Logic Control Voltage
5	GND	SPST Ground
6	RF2S	SPST RF Port 2
7	RF1S	SPST RF Port 1
8	RF1P	PTIC RF Input
9	BIAS	PTIC DC Bias Voltage

Table 2. VCC TRUTH TABLE FOR RF CHANNEL OPERATING MODE

VCC	Mode
Low	RF1S to RF2S Isolated
High	RF1S to RF2S On

Table 3. MAXIMUM RATINGS

Rating	Symbol	Value	Unit
RF Input Power (all RF Ports) (F ₀ =950MHz, 20% DC, VSWR=1:1, T _A =25C)	Pin	+38.5	dBm
DC Supply Voltage	V _{DD}	-0.3 to 3.6	V
Control Pin Voltage	V _{CC}	-0.3 to 3.3	V
Operating Temperature Range	T _{OP}	–30 to +85	°C
Storage Temperature Range	TSTG	–55 to 125	°C
ESD Capability, HBM	ESDHBM	500	V
ESD Capability, CDM	ESDCDM	500	V

1. Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. RECOMMENDED OPERATING RANGES

Rating	Symbol	Min	Тур	Max	Unit
Operating Frequency		0.6		3.8	GHz
DC Supply Voltage	V _{DD}	1.7	2.8	3.3	V
Control Voltage High	V _{CCH}	1.5	1.8	3.0	V
Control Voltage Low	V _{CCL}	0	0	0.3	V
PTIC Operating Bias Voltage	V _{BIAS}	1.0		24	V

Table 5. ELECTRICAL CHARACTERISTICS - LINEAR PARAMETERS

(V_{DD} = 2.8 V, V_{CCL} = 0 V, V_{CCH} = 1.8 V, T_A = 25 °C, Z_0 = 50 $\Omega)$

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SPST	•	•				
Insertion Loss	F ₀ = 0.6–1.0 GHz	IL		0.13	0.15	dBM
(RF1S to RF2S)	F ₀ = 1.0–2.2 GHz	IL		0.15	0.20	dBM
	F ₀ = 2.2–3.0 GHz	IL		0.18	0.26	dBM
	F ₀ = 3.0–3.8 GHz	IL		0.23	0.36	dBM
Isolation	F ₀ = 0.6–1.0 GHz	ISO	21	23		dBM
(RF1S to RF2S)	F ₀ = 1.0–2.2 GHz	ISO	15	17		dBM
	F ₀ = 2.2–3.0 GHz	ISO	11	13		dBM
	F ₀ = 3.0–3.8 GHz	ISO	9	11		dBM
On Resistance (RF1S to RF2S)	F ₀ = DC	R _{ON}		1.3	1.4	Ω
Off Capacitance (RF1S to RF2S)	F ₀ = 500 MHz	C _{OFF}		130	140	fF
P 0.1 dB	F ₀ = 950 MHz, 20%DC	P ₀ .1 dB		+45		dBm
RF Peak Voltage (RF1S to RF2S, RF2S to RF1S)	F ₀ = 950 MHz. RF1S to RF2S isolated	V		60		V
PTIC		•	•		•	

Capacitance	

Capacitance	VBIAS = 2 V	2.46	2.7	2.94	pF
	VBIAS = 24 V	0.42	0.53	0.64	pF
Q (Note 2)	F ₀ = 0.6 GHz, VBIAS = 2 V		70		
	F ₀ = 0.6 GHz, VBIAS = 24 V		35		
	F ₀ = 2.7 GHz, VBIAS = 2 V		40		
	F ₀ = 2.7 GHz, VBIAS = 24 V		20		
	F ₀ = 3.8 GHz, VBIAS = 2 V		10		
	F ₀ = 3.8 GHz, VBIAS = 24 V		10		
Transition Time (Note 3)	C _{MIN} to C _{MAX}		66	72	μS
	C _{MAX} to C _{MIN}		48	52	μS

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Sample testing only. RF1P and R2P must be connected to DC ground
3. Sample testing only. PTIC Control IC Turbo Mode must be used

Table 6. ELECTRICAL CHARACTERISTICS - NON-LINEAR PARAMETERS

(V_{DD} = 2.8 V, V_{CCL} = 0 V, V_{CCH} = 1.8 V, T_A = 25 $^\circ\text{C},$ Z_0 = 50 $\Omega)$

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SPST						
Second Harmonic	LTE TX $F_0 = 0.6-3.8$ Ghz, P _{IN} = 26 dBm	2 F ₀		-90	-80	dBM
	GSM LB F ₀ = 824–915 Mhz, P _{IN} = 35 dBm	2 F ₀		-65	-55	dBM
	GSM HB $F_0 = 1710-1910$ Mhz, $P_{IN} = 33$ dBm	2 F ₀		-70	-60	dBM
Third Harmonic	LTE TX F ₀ = 0.6–3.8 GHz, P _{IN} = 26 dBm	3 F ₀		-90	-80	dBM
	GSM LB F ₀ = 824–915 MHz, P _{IN} = 35 dBm	3 F ₀		-65	-55	dBM
	GSM HB F ₀ = 1710–1910 MHz, P _{IN} = 33 dBm	3 F ₀		-75	-65	dBM
2 nd Order Intermodulation	Refer to Table 7	IMD2		-115	-105	dBM
3 rd Order Intermodulation	Refer to Table 8	IMD3		-115	-105	dBM
PTIC						
Second Harmonic (Note 4)	F_0 = 0.9 GHz, V _{BIAS} = 2 V, P _{IN} = +23 dBm	2 F ₀		-75	-70	dBM
	$F_0 = 0.9 \text{ GHz}, \text{ V}_{\text{BIAS}} = 24 \text{ V},$ $P_{\text{IN}} = +23 \text{ dBm}$	2 F ₀		-85	-80	dBM
Third Harmonic (Note 4)	F_0 = 0.9 GHz, V_{BIAS} = 2 V, P_{IN} = +23 dBm	3 F ₀		-63	-58	dBM
	F_0 = 0.9 GHz, V_{BIAS} = 24 V, P_{IN} = +23 dBm	3 F ₀		-98	-90	dBM
Third Order Intercept Point	F_1 = 850 MHz, F_2 = 860 MHz, P_{IN} = 25 dBm/Tone, V_{BIAS} = 2 V	IIP3		73		dB
	F_1 = 850 MHz, F_2 = 860 MHz, P_{IN} = 25 dBm/Tone, V_{BIAS} = 24 V	IIP3		83		dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. PTIC Harmonics are measured in the reflect configuration

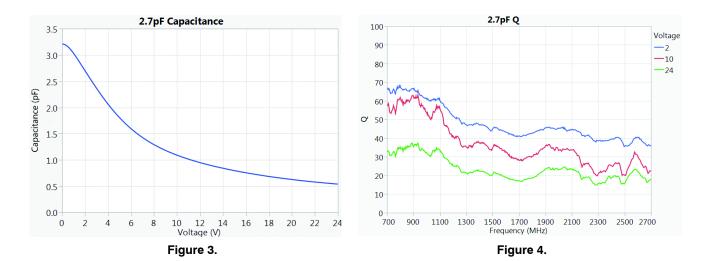
Table 7. IMD2 TEST CONDITIONS

Band	IN–Band Frequency MHz	CW Carrier MHz	dBm	CW Interferer MHz	dBm
1 Low	2140	1950	+20	190	-15
1 High	2140	1950	+20	1090	-15
5 High	881.5	836.5	+20	45	-15
5 High	881.5	836.5	+20	1718	-15

Table 8. IMD2 TEST CONDITIONS

Band	IN–Band Frequency MHz	CW Carrier MHz	dBm	CW Interferer MHz	dBm
1 Low	2140	1950	+20	190	–15
5 High	881.5	836.5	+20	791.5	-15

TYPICAL PERFORMANCE CURVES



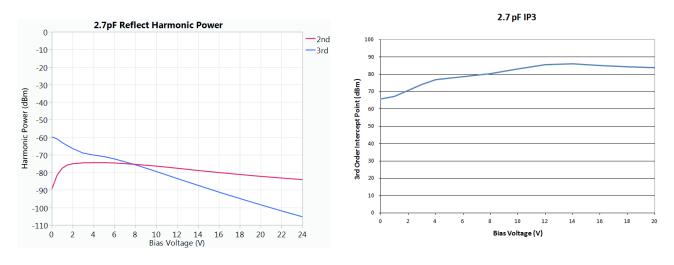


Figure 5.

Figure 6.

PACKAGE DIMENSIONS ECP9 CASE TBD

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